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CONFIRMATION NO. 4316

<b>SERIAL NUMBER</b> 10/757,276	<b>FILING OR 371(c) DATE</b> 01/14/2004 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2813	<b>ATTORNEY DOCKET NO.</b> MI22-2475
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a CON of 09/602,089 06/22/2000 PAT 6,686,298

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

None S.W.S.

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 04/16/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	<b>STATE OR COUNTRY</b> ID	<b>SHEETS DRAWING</b> 5	<b>TOTAL CLAIMS</b> 20	<b>INDEPENDENT CLAIMS</b> 4
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after allowance				
Verified and Acknowledged Examiner's Signature: <u>S.W.S.</u> Initials: _____				

## ADDRESS

21567

## TITLE

Method of forming a structure over a semiconductor substrate

<b>FILING FEE RECEIVED</b> 1756	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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